

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>ZHENGANG LI</td> <td>01/10/2014</td> </tr> <tr> <td>CHEN HUANG</td> <td>01/10/2014</td> </tr> <tr> <td>YUN YANG</td> <td>01/10/2014</td> </tr> </tbody> </table>		Name	Execution Date	ZHENGANG LI	01/10/2014	CHEN HUANG	01/10/2014	YUN YANG	01/10/2014				
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CORRESPONDENCE DATA													
Fax Number:	(212)704-6288												
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ATTORNEY DOCKET NUMBER:	238860.000007
NAME OF SUBMITTER:	KEVIN HE
Signature:	/XIN (KEVIN) HE 51,794/
Date:	02/20/2014
Total Attachments: 3 source=assignment7#page1.tif source=assignment7#page2.tif source=assignment7#page3.tif	

ASSIGNMENT

WHEREAS We, Zhengang Li, Chen Huang, Yun Yang, hereinafter referred to Assignors), have made an invention entitled: INDUCTION UNIT, TOUCH DETECTING ASSEMBLY AND TOUCH SENSITIVE DEVICE for which we are the listed inventors for the application for United States Letters Patent referred to below as the Formal Application:

WHEREAS Shenzhen BYD Auto R&D Company Limited, whose mailing address is Part B, 1/F, BLDG#B2, Yucan Industrial Area, Lanzhu Road, Shenzhen Export Processing Zone, Shenzhen Grand Industrial Zone, Guangdong, 518118, P.R. and BYD COMPANY LIMITED whose mailing address is No.3009, BYD Road, Pingshan, Shenzhen, Guangdong, 518118, P.R.China(hereinafter referred to as Assignees), are desirous of obtaining the entire right, title and interest in and to this invention in all countries throughout the world, and in and to the above-identified Formal Application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application

NOW, THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignees is hereby acknowledged, We, as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignees, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention, the above-identified patent application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignees, their successors and assigns, in accordance with the terms of this Assignment;

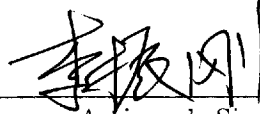
AND, WE HEREBY covenant that we have the full right to convey the interest assigned by this Assignment, and have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that we will, without further consideration, communicate with Assignees, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignees, its successors or assigns, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent prosecution for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignees, its successors and assigns;

AND, WE HEREBY covenant and agree that we will assign, and hereby do assign, to Assignees, its lawful successors and assigns OUR entire right, title, and interest in and to any and all patent applications, both United States and foreign, and all Letters Patent that may be granted thereon, that claim priority to this invention or to the above-identified provisional or non-provisional applications in any manner, such applications specifically including, but not limited to, divisionals, continuations, continuations-in-part, and all other provisional and non-provisional applications.

1st Assignor: Zhengang Li

Address of 1st Assignor: No. 3009 Byd Road, Pingshan, Shenzhen, Guangdong, China 518118

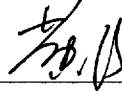


Assignor's Signature

Date: 2014.01.10

2nd Assignor: Chen Huang

Address of 1st Assignor: No. 3009 Byd Road, Pingshan, Shenzhen, Guangdong, China 518118

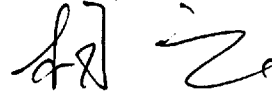


Assignor's Signature

Date: 2014.01.10

3rd Assignor: Yun Yang

Address of 3rd Assignor: No. 3009 Byd Road, Pingshan, Shenzhen, Guangdong, China 518118



Assignor's Signature

Date: 2014.01.10

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